



#### Protection for Ethernet lines

#### **Features**

- Differential and common mode protection
- Telcordia GR1089 Intrabuilding: 150 A, 2/10 µs
- ITU-T K20/21: 40 A, 5/310 µs
- Low capacitance: 13 pF max at 0 V
- UL94 V0 approved resin
- SO-8 package is JEDEC registered

#### **Benefits**

- Trisil<sup>™</sup> technology is not subject to ageing and provides a fail safe mode in short circuit for a better protection.
- This series is used to help equipment to meet main standards such as UL61950, IEC 950 / CSA C22.2 and UL1459.

#### Complies with the following standards

- IEC 61000-4-2: Level 4
  - 15 kV (air discharge)
  - 8 kV (contact discharge)
- MIL STD 883E-Method 3015-7: class3:
  - 25 kV (Human body model)
- Telcordia GR-1089 Core: 100 A, 2/10 µs
- ITU-T K20/21: 37.5 A, 5/310 µs
- IEC 61000-4-5: 4 kV, 42 Ω, 96 A, 8/20 μs
- IEC 61000-4-4 EFT : 40A (5/50ns)

### **Applications**

This series can meet subscriber and central office requirements.

- Protection against telecommunications surge standards on:
  - 10/100 Mbps Ethernet
  - T1 / E1 line cards

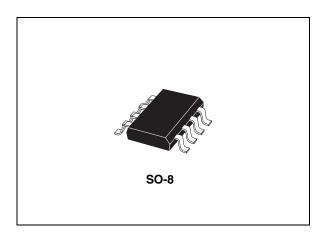
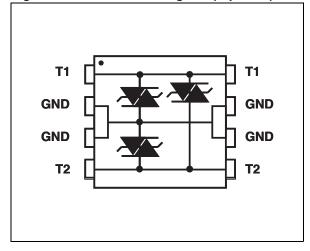


Figure 1. Schematic diagram (top view)



### **Description**

The ETP01 series is a low capacitance transient surge arrestor designed for protection of high debit rate communication network. Planar technology used combines a high surge capability to comply with Telcordia GR1089 Intrabuilding and ITU-T K20/21, and low capacitance to avoid distortion of high speed signals such as Ethernet.

TM: Trisil is a trademark of STMicroelectronics

Characteristics ETP01-xx21

### 1 Characteristics

Table 1. Absolute ratings  $(T_{amb} = 25 \degree C)$ 

Symbol	Parameter	Value	Unit	
I <sub>pp</sub>		5/310 µs	40	Α
	Peak pulse current <sup>(1)</sup>	8/20 µs	100	Α
		2/10 µs	150	Α
I <sub>TSM</sub>	Non repetitive surge peak on state current	t = 20 ms	8	Α
T <sub>stg</sub> T <sub>j</sub>	Storage temperature range Operating junction temperature range		-55 to 150 -40 to 150	°C
T <sub>L</sub>	Maximum temperature for soldering during 10 s	260	°C	

Surge capability tested according to ITU-T K20/21 and Telcordia GR1089 Intrabuilding connections (Metallic and Longitudinal tests).

Table 2. Electrical characteristics ( $T_{amb} = 25$  °C)

	I <sub>RM</sub> @	V <sub>RM</sub>	I <sub>RM</sub> @ V <sub>RM</sub>		V <sub>bo</sub>	I <sub>H</sub>	С	С
Order code	μA typ.	v	μA max.	V	V max.	mA min.	pF max. <sup>(1)</sup>	pF max. <sup>(2)</sup>
ETP01-1621	0.01	3.3	1	16	25	30	16	13
ETP01-2821	0.01	3.3	1	28	36	30	16	13

<sup>1.</sup> Test conditions: Capacitance between I/O and GND,  $V_R = 0\ V$  bias,  $V_{RMS} = 1\ V$ ,  $F = 1\ MHz$ 

<sup>2.</sup> Test conditions: Capacitance between I/O and I/O,  $V_R = 0 \ V$  bias,  $V_{RMS} = 1 \ V$ ,  $F = 1 \ MHz$ 

ETP01-xx21 Characteristics

Figure 2. Non repetitive surge peak on-state current versus overload duration

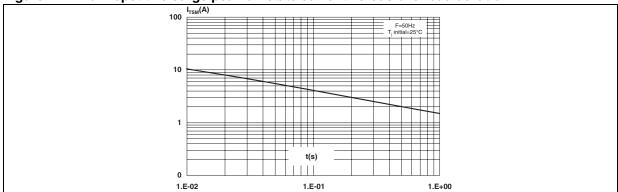
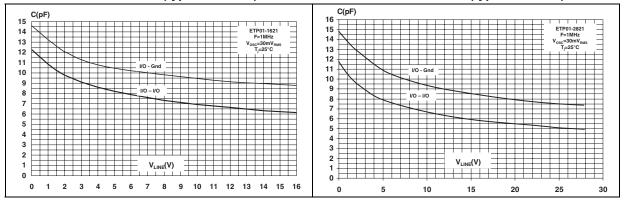


Figure 3. Junction capacitance versus reverse voltage applied for ETP01-1621 (typical values)

Figure 4. Junction capacitance versus reverse voltage applied for ETP01-2821 (typical values)



# 2 Application information

Figure 5. Application schematic for Ethernet 10/100 Mbps

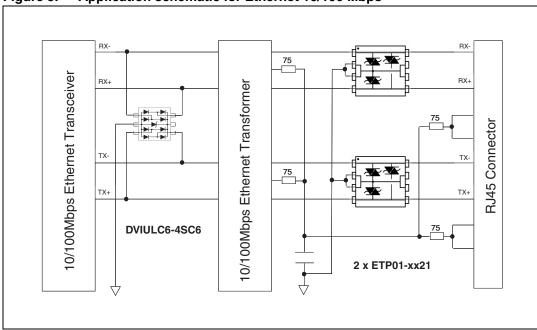
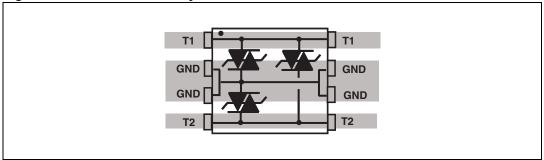


Figure 6. Recommended layout



## 3 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 3. SO-8 dimensions

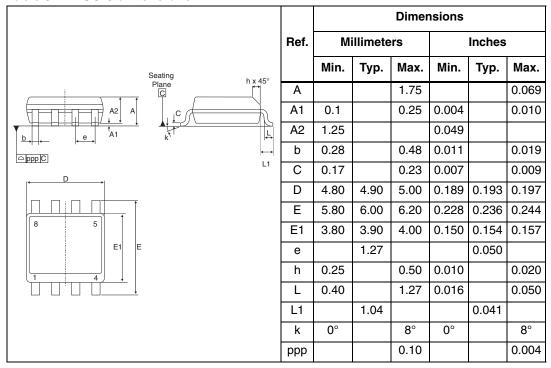
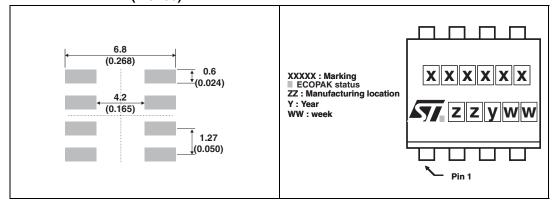


Figure 7. Footprint dimensions in mm (inches)

Figure 8. Marking



# 4 Ordering information

Table 4. Ordering information

Order code	Marking	Weight	Base qty	Delivery mode
ETP01-1621RL	ETP162	0.08 g	2500	Tape and reel
ETP01-2821RL	ETP282	0.08 g	2500	Tape and reel

# 5 Revision history

Table 5. Document revision history

Date	Revision	Changes	
04-Mar-2008	1	Initial release.	
24-Sep-2009	2	Updated order code in <i>Table 4</i> and surge values.	
19-Feb-2010 3		Updated <i>Figure 1</i> caption to indicate top view. Updated graphic in <i>Table 3</i> to facilitate pin 1 identification. Updated <i>Figure 8</i> to show ECOPACK status marking.	
10-May-2011	4	Updated: Applications on page 1.	

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